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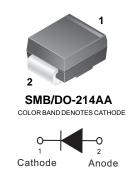
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January 2016

# S3AB - S3MB 3 A, 50 V - 1000 V Surface Mount Rectifiers

### **Features**

- · Glass Passivated Chip Junction
- High Surge Current Capacity
- Low Forward Voltage: 1.15 V Maximum
- · UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- · RoHS Compliant / Green Molding Compound
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable



# **Ordering Information**

Part Number	Top Mark	Package	Packing Method
S3AB, NRVS3AB	S3AB	DO-214AA (SMB)	Tape and Reel
S3BB, NRVS3BB	S3BB	DO-214AA (SMB)	Tape and Reel
S3DB, NRVS3DB	S3DB	DO-214AA (SMB)	Tape and Reel
S3GB, NRVS3GB	S3GB	DO-214AA (SMB)	Tape and Reel
S3JB, NRVS3JB	S3JB	DO-214AA (SMB)	Tape and Reel
S3KB, NRVS3KB	S3KB	DO-214AA (SMB)	Tape and Reel
S3MB, NRVS3MB	S3MB	DO-214AA (SMB)	Tape and Reel

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value						Unit	
	Farameter		S3BB	S3DB	S3GB	S3JB	S3KB	S3MB	Oill
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage		100	200	400	600	800	1000	V
V <sub>RMS</sub>	RMS Reverse Voltage		70	140	280	420	560	700	V
$V_R$	DC Blocking Voltage		100	200	400	600	800	1000	V
I <sub>F(AV)</sub>	Average Forward Rectified Current				3				Α
I <sub>FSM</sub>	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load 80			Α					
TJ	Operating Junction Temperature Range		-55 to +150					°C	
T <sub>STG</sub>	Storage Temperature Range -55 to +150				°C				

#### Thermal Characteristics(1)

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Typical Thermal Resistance, Junction-to-Ambient	148	°C/W
ΨJL	Typical Thermal Characteristics, Junction-to-Lead	14	°C/W

#### Note:

1. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm per JESD51-3.

#### **Electrical Characteristics**

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V <sub>F</sub>	Instantaneous Forward Voltage <sup>(2)</sup>	I <sub>F</sub> = 3 A			1.15	V
I <sub>R</sub>	Reverse Current at Rated V <sub>R</sub>	T <sub>J</sub> = 25°C			10	μΑ
		T <sub>J</sub> = 125°C			250	
T <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>rr</sub> = 0.25 A		1.5		μs
CJ	Junction Capacitance	V <sub>R</sub> = 4 V, f = 1 MHz		40		pF

#### Note:

2. Pulse test with PW =  $300 \mu s$ , 1% duty cycle

## **Typical Performance Characteristics**

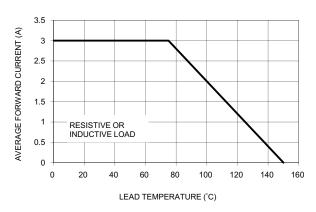


Figure 1. Forward Current Derating Curve

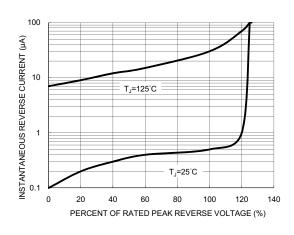


Figure 2. Typical Reverse Characteristics

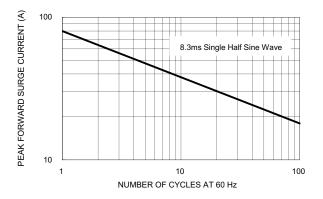


Figure 3. Maximum Non-Repetitive Forward Surge Current

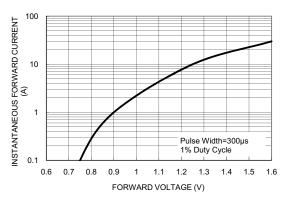


Figure 4. Typical Forward Characteristics

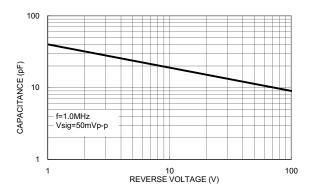


Figure 5. Typical Junction Capacitance

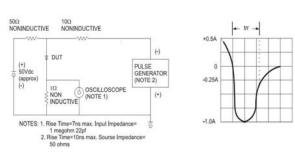
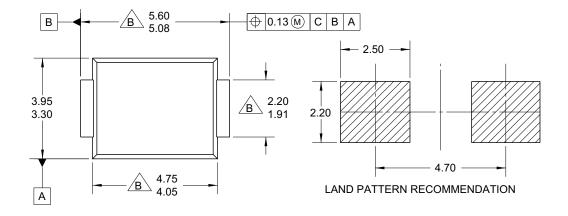
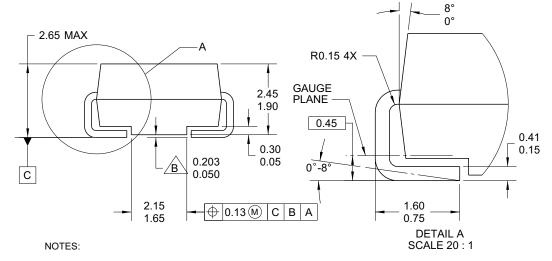


Figure 6. Reverse Recovery Time Characteristic and Test Circuit Diagram

# **Physical Dimensions**





- A. EXCEPT WHERE NOTED CONFORMS TO
  JEDEC DO214 VARIATION AA.
  B DOES NOT COMPLY JEDEC STD. VALUE.
  C. ALL DIMENSIONS ARE IN MILLIMETERS.
  D. DIMENSIONS ARE EXCLUSIVE OF BURRS,
  MOLD FLASH AND TIE BAR PROTRUSIONS.
  E. DIMENSION AND TOLERANCE AS PER ASME

- Y14.5-1994.
- LAND PATTERN STD. DIOM5336X240M.
- G. DRAWING FILE NAME: DO214AAREV1

Figure 7. 2-LEAD, SMB, JEDEC DO-214, VARIATION AA





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Definition of Terms		
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